



US00D911331S

(12) **United States Design Patent**  
**Kim et al.**

(10) **Patent No.:** **US D911,331 S**

(45) **Date of Patent:** **\*\* Feb. 23, 2021**

(54) **THREE DIMENSIONAL FACETED IDENTIFICATION CHIP**

(71) Applicant: **Lexmark International, Inc.**,  
Lexington, KY (US)

(72) Inventors: **Hyeob Kim**, Independence, KY (US);  
**Thomas Eugene Pangburn**,  
Winchester, KY (US); **Scott Richard Castle**,  
Lexington, KY (US); **Robert Henry Muyskens**,  
Lexington, KY (US); **Brant Dennis Nystrom**,  
Lexington, KY (US); **Samuel Leo Rhodus**,  
Lexington, KY (US)

(73) Assignee: **LEXMARK INTERNATIONAL, INC.**,  
Lexington, KY (US)

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/684,253**

(22) Filed: **Mar. 19, 2019**

(51) **LOC (13) Cl.** ..... **14-02**

(52) **U.S. Cl.**  
USPC ..... **D14/384**

(58) **Field of Classification Search**  
USPC ..... D14/356-358, 383-385, 420, 426, 427,  
D14/432-439, 447, 453, 454, 217, 253,  
D14/299, 307; D13/107, 108, 133, 146,  
D13/147, 152, 154, 156, 158, 162, 162.1,  
D13/168, 173, 177, 102; 235/441, 451,  
235/492, 380, 439, 375; 361/679.31, 600,  
361/679.01, 679.02  
CPC ..... G07C 9/00103; G07C 9/00039; G07C  
9/00904; G06K 5/00; G06K 7/01  
See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

1,734,979 A \* 11/1929 Persons ..... E01F 9/619  
359/549  
2,538,638 A \* 1/1951 Wilson ..... C03B 11/082  
65/305

D207,930 S \* 6/1967 Kotler ..... D10/111  
5,329,407 A \* 7/1994 Sasaki ..... G02B 7/008  
359/846  
D380,402 S \* 7/1997 Binder, Sr. .... D10/111  
D432,939 S \* 10/2000 Hooglander ..... D11/80  
D670,416 S \* 11/2012 Renshaw ..... D26/28  
D774,687 S \* 12/2016 Dennis ..... D26/122  
D774,688 S \* 12/2016 Dennis ..... D26/122  
D790,520 S \* 6/2017 Kim ..... D14/248  
D790,763 S \* 6/2017 Lai ..... D26/139  
D831,261 S \* 10/2018 Ding ..... D26/88  
D851,327 S \* 6/2019 Morelock ..... D26/139  
D852,395 S \* 6/2019 Chen ..... D26/36  
10,333,200 B2 \* 6/2019 Moon ..... H01Q 7/00  
D857,696 S \* 8/2019 Oh ..... D14/383  
D865,765 S \* 11/2019 Min ..... D14/384

\* cited by examiner

*Primary Examiner* — Austin Murphy

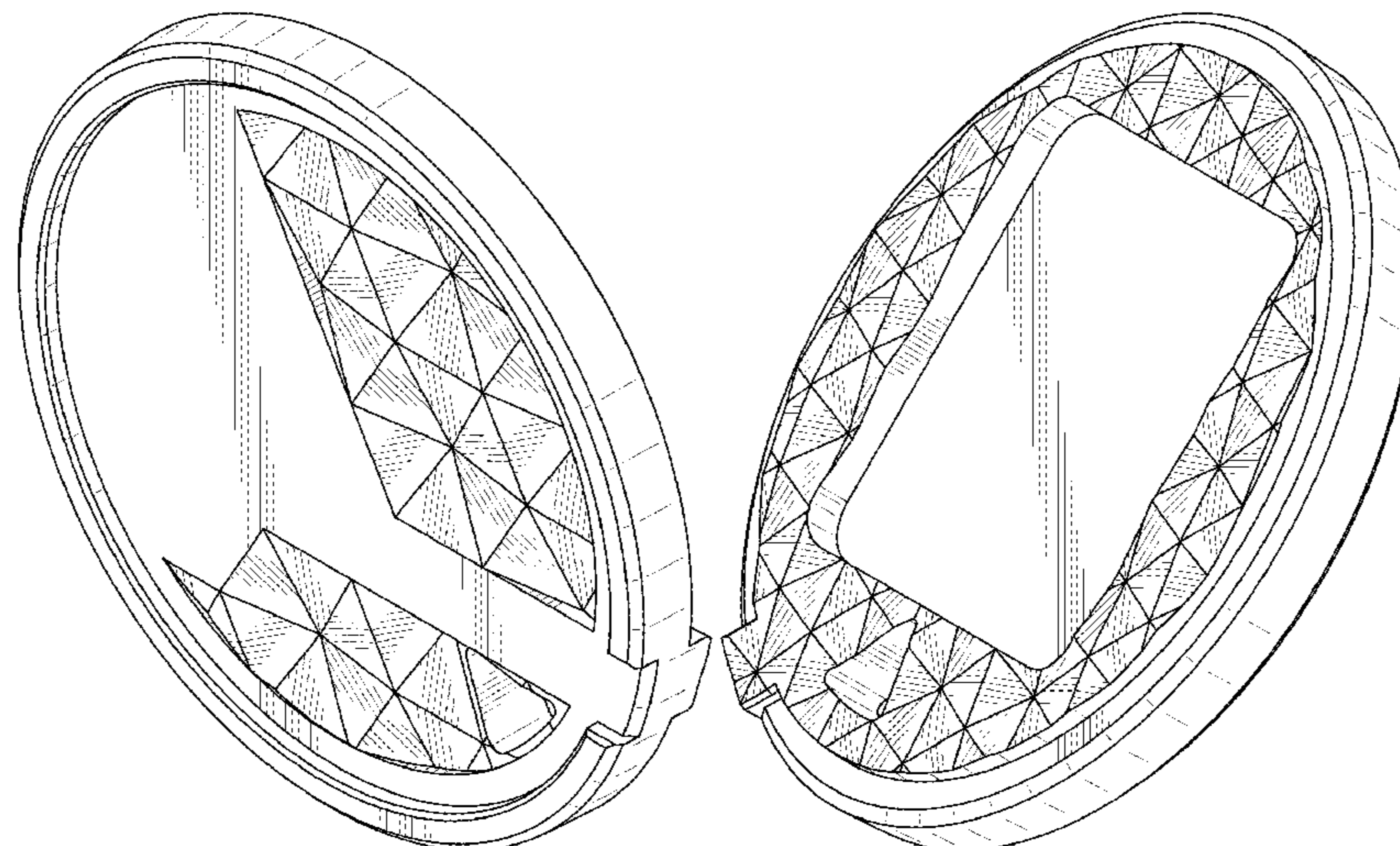
(57) **CLAIM**

The ornamental design for three dimensional faceted identification chip, as shown and described.

**DESCRIPTION**

FIG. 1 is a front, top, and right side perspective view of a three dimensional faceted identification chip showing our new design;  
FIG. 2 is a rear, bottom, and left side perspective thereof;  
FIG. 3 is front elevation thereof;  
FIG. 4 is a right side elevation thereof;  
FIG. 5 is a rear elevation thereof;  
FIG. 6 is a left side elevation thereof;  
FIG. 7 is a top plan view thereof;  
FIG. 8 is a bottom plan view thereof;  
FIG. 9 is a section view thereof, as identified in FIG. 3;  
FIG. 10 is a section view thereof, as identified in FIG. 3; and  
FIG. 11 is a section view thereof, as identified in FIG. 3.  
The features shown in broken lines depict environmental subject matter only and form no part of the claimed design.

**1 Claim, 7 Drawing Sheets**



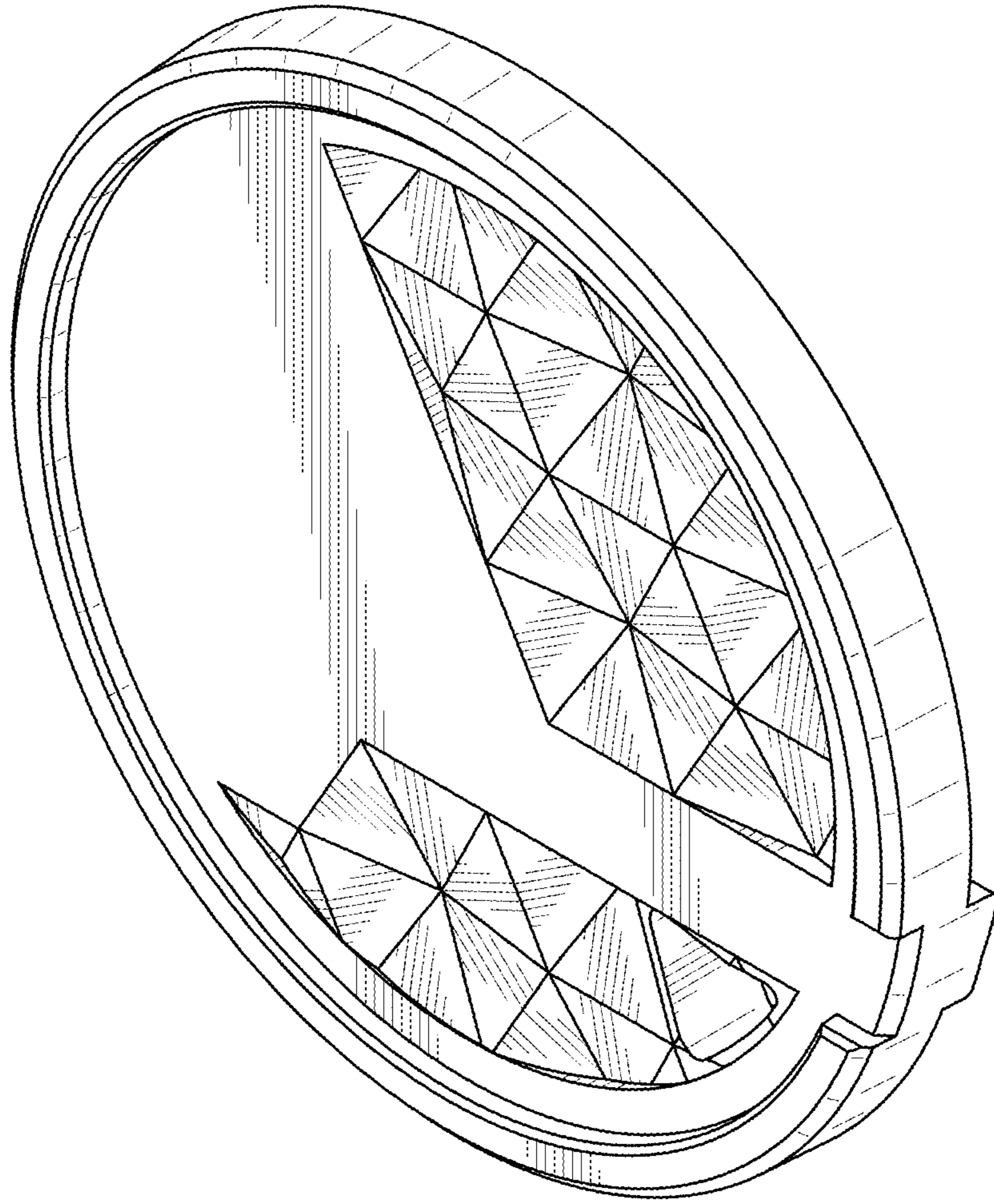


FIG. 1



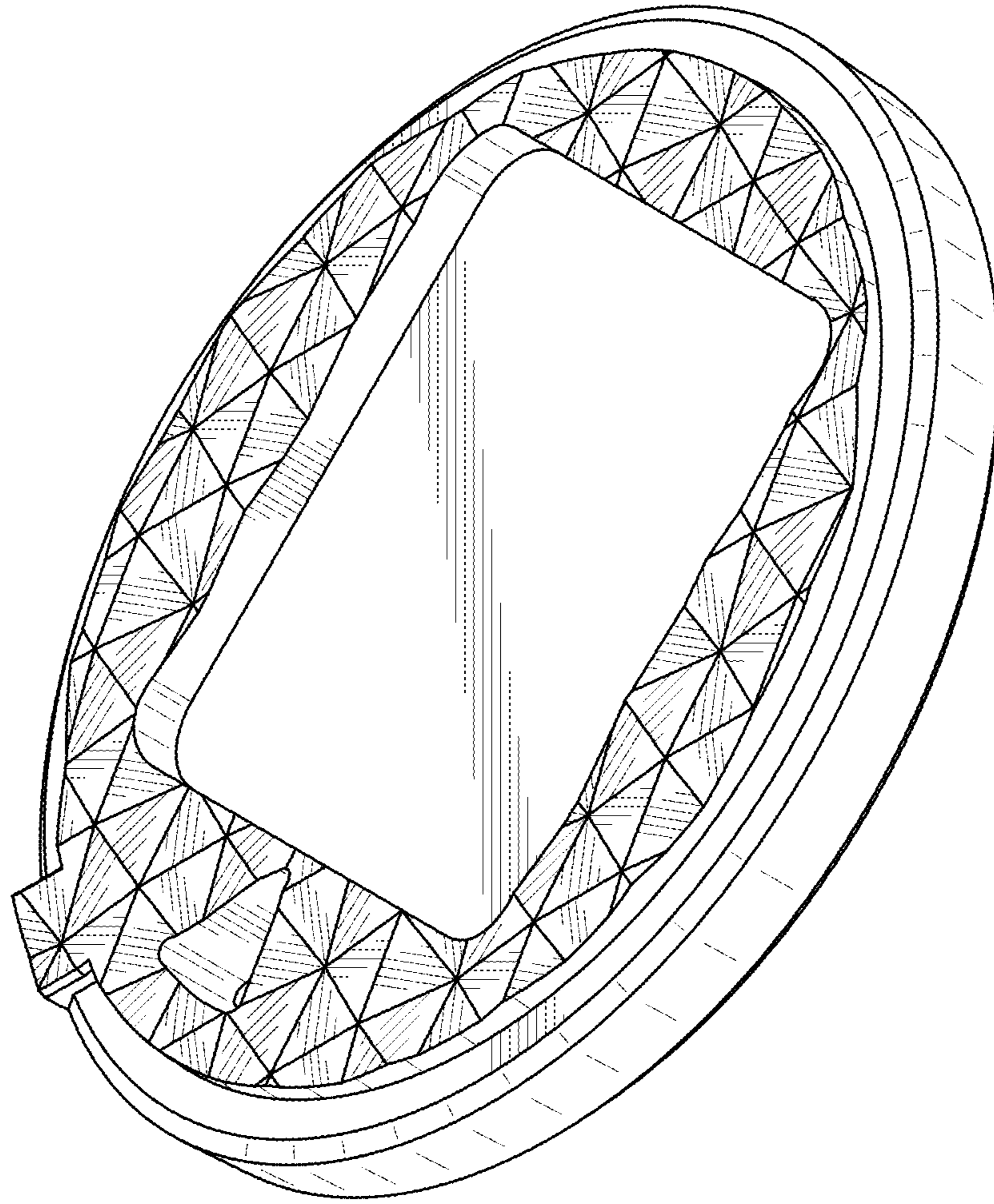


FIG. 2

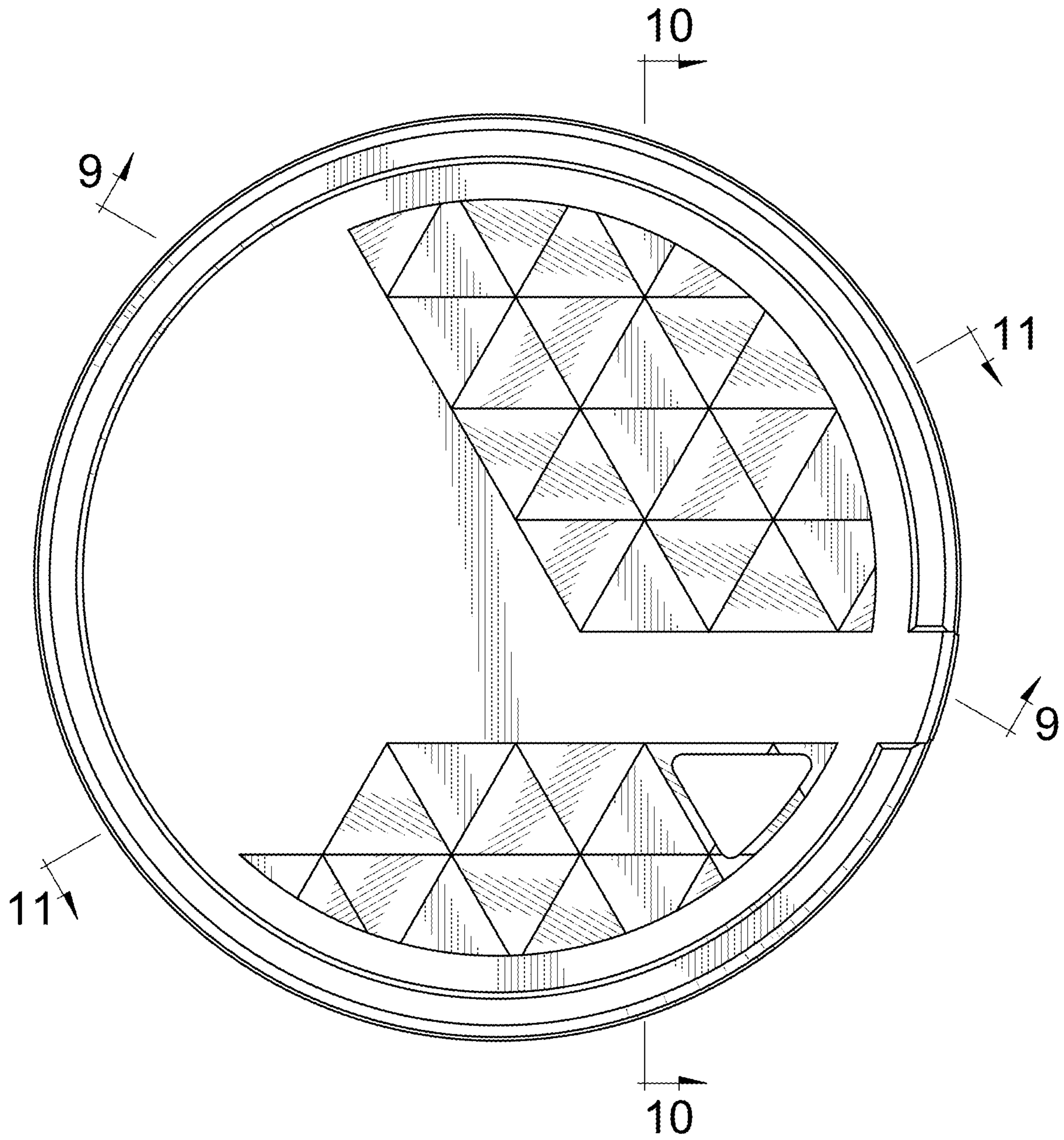


FIG. 3

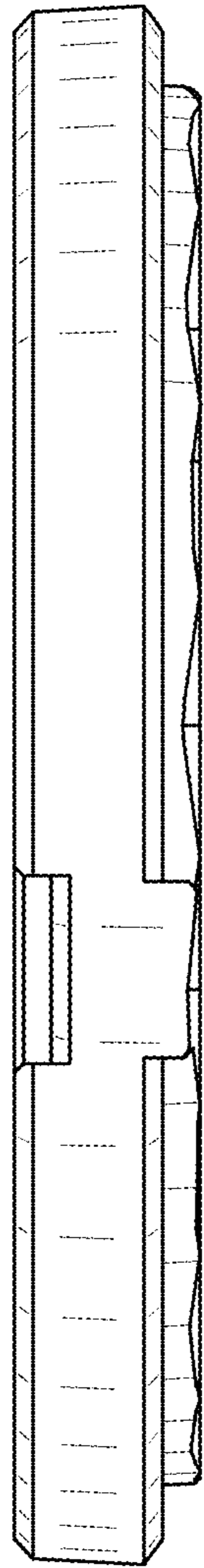


FIG. 4

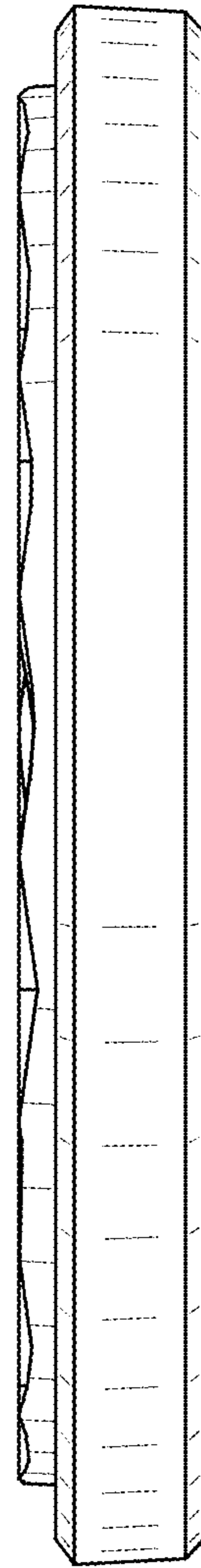


FIG. 6

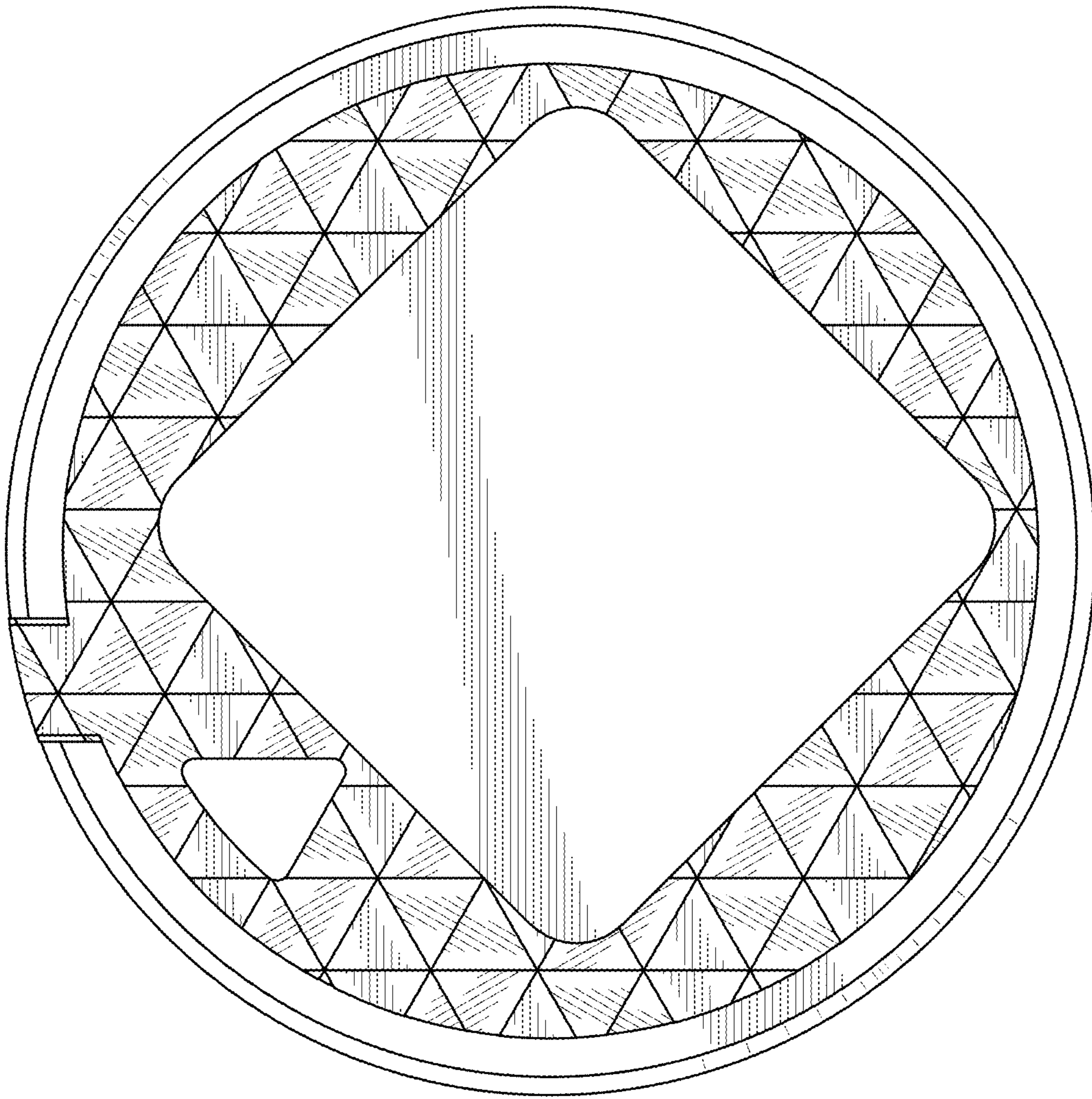


FIG. 5



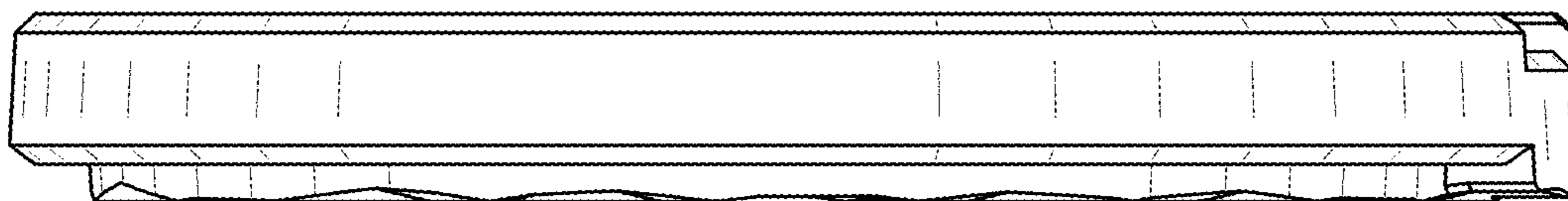


FIG. 7

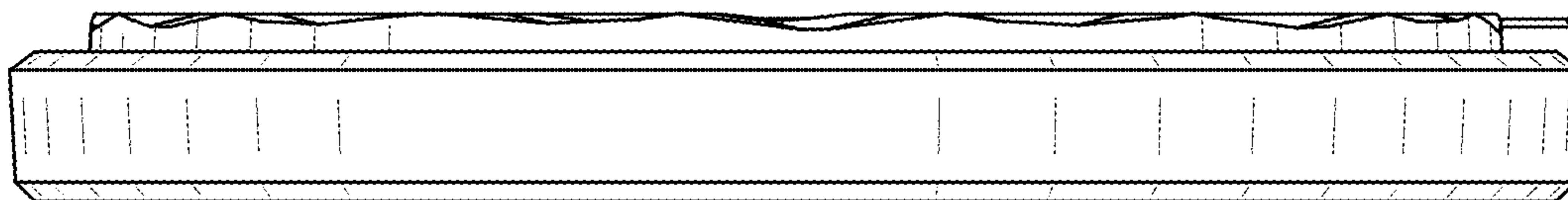


FIG. 8

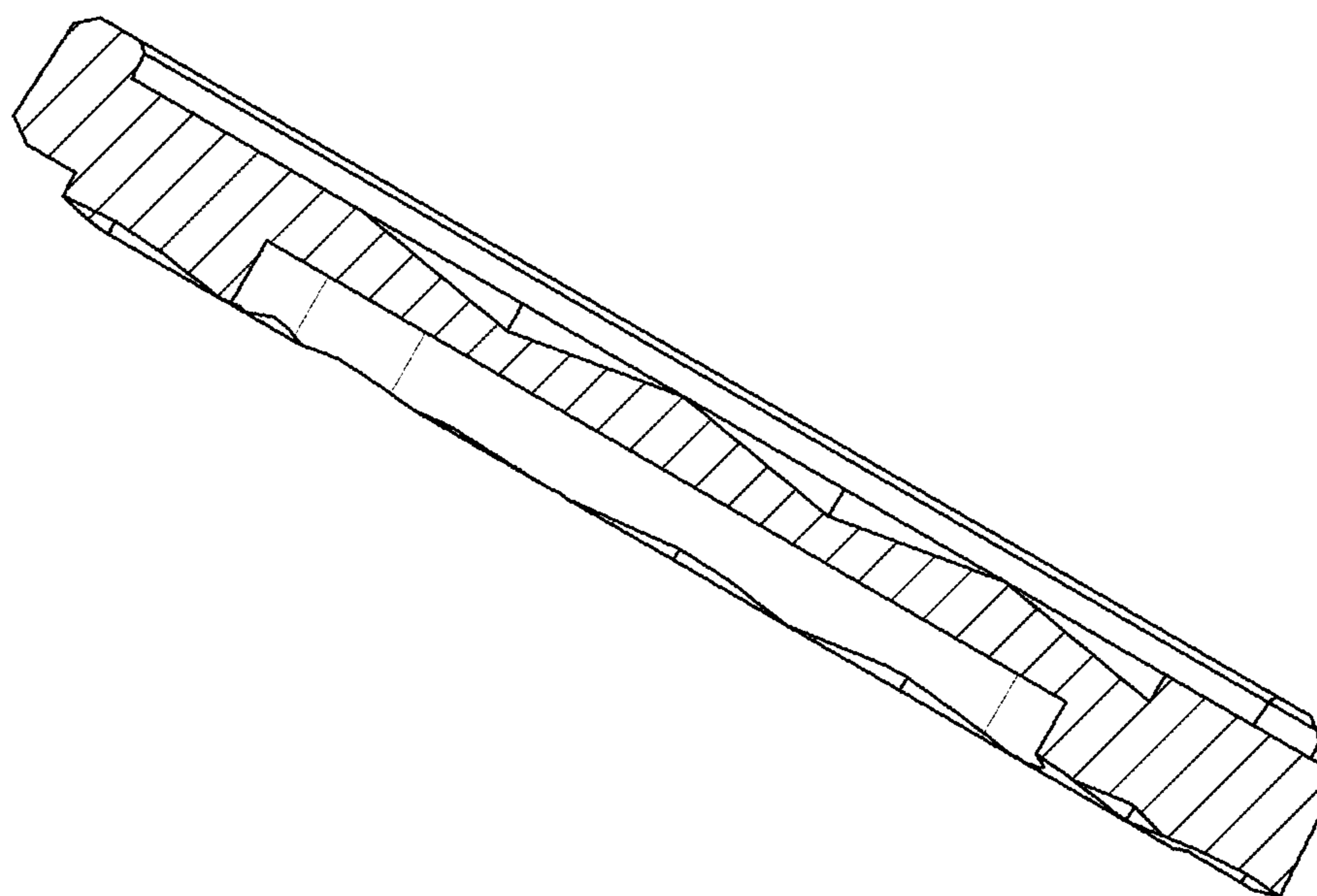


FIG. 9

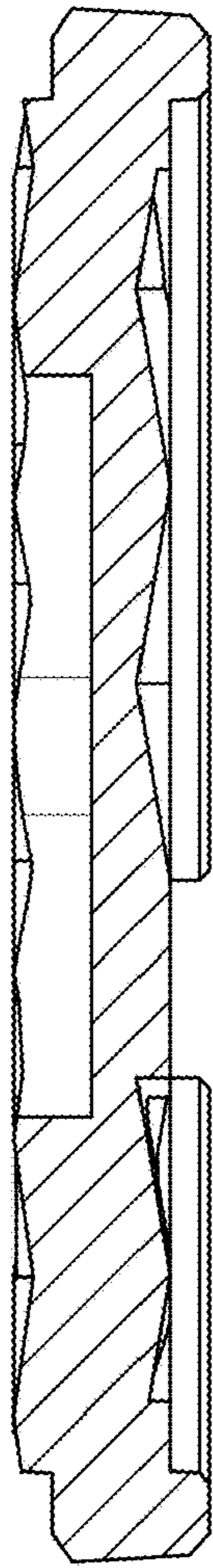


FIG. 10

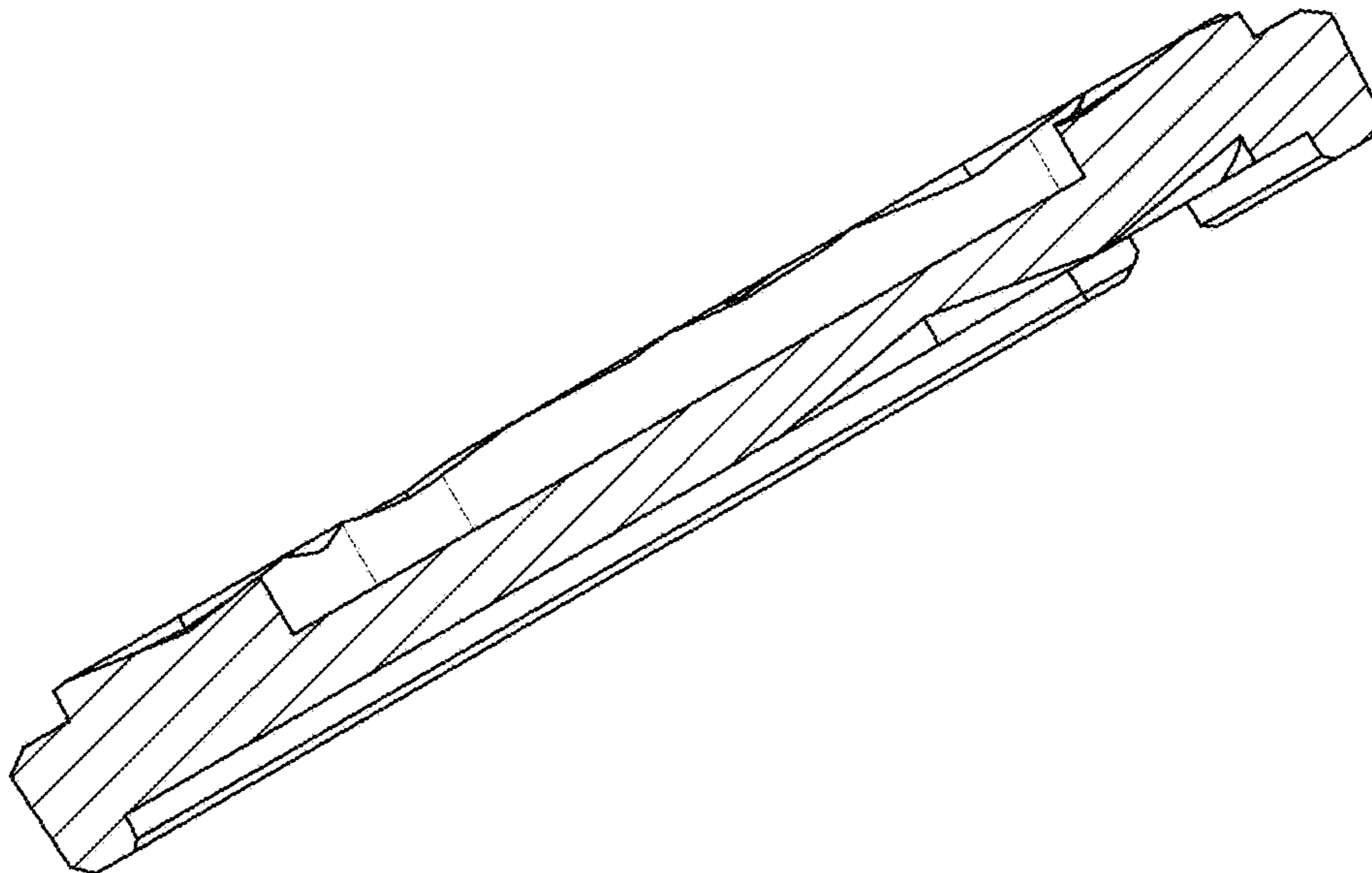


FIG. 11